

Datasheet

Operational Amplifiers Series

Low Noise Operational Amplifiers BA4510xxx

General Description BA4510 is dual operational amplifier with high gain. It has good performance of input referred noise voltage($6 \text{ nV}/\sqrt{\text{Hz}}$) and total harmonic distortion(0.007%). These are suitable for Audio applications.

Features

- High voltage gain
- Low input referred noise voltage
- Low distortion
- Wide operating supply voltage

Application

- Audio application
- Consumer electronics

Block Diagrams

Packages SOP8 SSOP-B8

TSSOP-B8 MSOP8

W(Typ.) x D(Typ.) x H(Max.) 5.00mm x 6.20mm x 1.71mm 3.00mm x 6.40mm x 1.35mm 3.00mm x 6.40mm x 1.20mm 2.90mm x 4.00mm x 0.90mm

5V/µs(Typ.)

•Key Specification

- Wide Operating Supply Voltage
 - (split supply) : ±1.0V to ±3.5V -20°C to +75°C
- Wide Temperature Range:
 - High Slew Rate:
 - Total Harmonic Distortion: 0.007%(Typ.)
- Input Referred Noise Voltage: $6 \, \text{nV} / \sqrt{\text{Hz}}$ (Typ.)

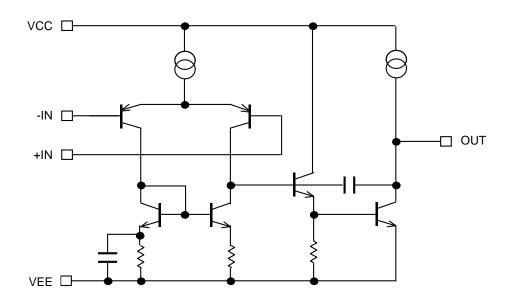


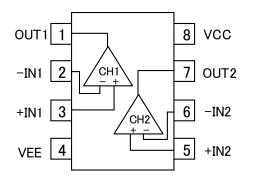
Figure 1. Simplified schematic

OProduct structure : Silicon monolithic integrated circuit OThis product is not designed protection against radioactive rays.



Pin Configuration(TOP VIEW)

SOP8, SSOP-B8, TSSOP-B8, MSOP8



| Pin No. | Symbol |
|---------|--------|
| 1 | OUT1 |
| 2 | -IN1 |
| 3 | +IN1 |
| 4 | VEE |
| 5 | +IN2 |
| 6 | -IN2 |
| 7 | OUT2 |
| 8 | VCC |

| Package | | | | | | | |
|---------|----------|-----------|-----------|--|--|--|--|
| SOP8 | SSOP-B8 | TSSOP-B8 | MSOP8 | | | | |
| BA4510F | BA4510FV | BA4510FVT | BA4510FVM | | | | |

Ordering Information

| В | А | 4 | 5 | 1 | 0 | Х | Х | Х | - | E2 | | |
|----------------|-----------------|---|---|---|---|-----------|---|---------------|---|-----------|-------------------------------|----------------|
| Part N BA45 | lumber 10xxx | r | | | | FV FVT | age : SOP8 : SSOF : TSSC : MSOI | P-B8)P-B8 | | E2: Embos | sed tap 3/SSOP ssed tap | P-B8/TSSOP-B8) |

●Line-up

| Topr | Operating Supply Voltage (split supply) | Supply Current (Typ.) | Slew Rate (Typ.) | Pac | ckage | Orderable Part Number | | |
|----------------|---|-----------------------------|---------------------|---------|--------------|--------------------------|--------------|--------------|
| | | | | SOP8 | Reel of 2500 | BA4510F-E2 | | |
| -20°C to +75°C | ±1.0V to ±3.5V | 5mA | 5V/µs | SSOP-B8 | Reel of 2500 | BA4510FV-E2 | | |
| -20 C 10 +75 C | ±1.0V t0 ±3.5V | SIIIA | SIIIA | SILIA | λ 5ν/μ5 | TSSOP-B8 | Reel of 2500 | BA4510FVT-E2 |
| | | | | MSOP8 | Reel of 3000 | BA4510FVM-TR | | |

● Absolute Maximum Ratings (Ta=25°C)

OBA4510

| Parameter | Symbol | | Ratings | Unit | |
|---------------------------------|---------|----------|---------------------|------|--|
| Supply Voltage | VCC-VEE | | +10 | V | |
| | | SOP8 | 620 ^{*1*5} | mW | |
| Power dissipation | Di | SSOP-B8 | 550 ^{*2*5} | | |
| | Pd | TSSOP-B8 | 500 ^{*3*5} | | |
| | | MSOP8 | 470 ^{*4*5} | | |
| Differential Input Voltage *6 | | Vid | VCC-VEE | V | |
| Input Common-mode Voltage Range | | Vicm | VEE to VCC | V | |
| Operating Supply Voltage | | Vopr | 2 to 7(±1 to ±3.5) | V | |
| Operating Temperature | | Topr | -20 to +75 | °C | |
| Storage Temperature | Tstg | | -40 to 125 | °C | |
| Maximum Junction Temperature | Tjmax | | +125 | °C | |

Note: Absolute maximum rating item indicates the condition which must not be exceeded.

Application of voltage in excess of absolute maximum rating or use out absolute maximum rated temperature environment may cause deterioration of characteristics.

*1 To use at temperature above $Ta=25^{\circ}C$ reduce 6.2mW/ $^{\circ}C$

*2 To use at temperature above Ta=25°C reduce 5.5mW/°C

*3 To use at temperature above Ta=25°C reduce 5.0mW/°C

*4 To use at temperature above Ta=25°C reduce 4.8mW/°C

*5 Mounted on a FR4 glass epoxy PCB(70mm×70mm×1.6mm).

*6 The voltage difference between inverting input and non-inverting input is the differential input voltage. Then input terminal voltage is set to more than VEE.

•Electrical Characteristics

OBA4510 (Unless otherwise specified VCC=+2.5V, VEE=-2.5V, Ta=25°C)

| Parameter | Symbol | | Limits | | Unit | Condition |
|----------------------------------|--------|------|--------|------|------------------------|--|
| Falanetei | Symbol | Min. | Тур. | Max. | Unit | Condition |
| Input Offset Voltage *7 | Vio | - | 1 | 6 | mV | RS=50Ω |
| Input Offset Current *7 | lio | - | 2 | 200 | nA | - |
| Input Bias Current *8 | lb | - | 80 | 500 | nA | - |
| Supply Current | ICC | 2.5 | 5.0 | 7.5 | mA | RL=∞, All Op-Amps |
| Maximum Output Voltage(High) | VOH | +2.0 | +2.4 | - | V | RL=10kΩ |
| Maximum Output Voltage(Low) | VOL | - | -2.4 | -2.0 | V | RL=10kΩ |
| Large Signal Voltage Gain | Av | 60 | 90 | - | dB | RL≧10kΩ |
| Input Common-mode Voltage Range | Vicm | -1.3 | - | +1.5 | V | - |
| Common-mode Rejection Ratio | CMRR | 60 | 80 | - | dB | - |
| Power Supply Rejection Ratio | PSRR | 60 | 80 | - | dB | RS=50Ω |
| Slew Rate | SR | - | 5.0 | - | V/µs | Av=1 |
| Total Harmonic Distortion+ Noise | THD+N | - | 0.007 | - | % | Av=20dB, RL=10kΩ, VIN=0.05Vrms, f=1kHz DIN-AUDIO |
| Input Referred Noise Voltage | Vn | - | 6 | - | nV/ $\sqrt{\text{Hz}}$ | RS=100Ω, Vi=0V, f=1kHz |
| input ivereneu Noise voltage | VII | - | 0.7 | - | µVrms | DIN-AUDIO |
| Channel Separation | CS | - | | - | dB | R1=100Ω, f=1kHz |

*7 Absolute value

*8 Current direction: Since first input stage is composed with PNP transistor, input bias current flows out of IC.

Description of electrical characteristics

Described here are the terms of electric characteristics used in this datasheet. Items and symbols used are also shown. Note that item name and symbol and their meaning may differ from those on another manufacture's document or general document.

1. Absolute maximum ratings

Absolute maximum rating item indicates the condition which must not be exceeded. Application of voltage in excess of absolute maximum rating or use out of absolute maximum rated temperature environment may cause deterioration of characteristics.

1.1 Power supply voltage (VCC/VEE)

Indicates the maximum voltage that can be applied between the positive power supply terminal and negative power supply terminal without deterioration or destruction of characteristics of internal circuit.

- 1.2 Differential input voltage (Vid) Indicates the maximum voltage that can be applied between non-inverting terminal and inverting terminal without deterioration and destruction of characteristics of IC.
- 1.3 Input common-mode voltage range (Vicm)

Indicates the maximum voltage that can be applied to non-inverting terminal and inverting terminal without deterioration or destruction of characteristics. Input common-mode voltage range of the maximum ratings not assure normal operation of IC. When normal operation of IC is desired, the input common-mode voltage of characteristics item must be followed.

1.4 Power dissipation (Pd)

Indicates the power that can be consumed by specified mounted board at the ambient temperature 25°C(normal temperature). As for package product, Pd is determined by the temperature that can be permitted by IC chip in the package (maximum junction temperature) and thermal resistance of the package.

2. Electrical characteristics item

2.1 Input offset voltage (Vio)

Indicates the voltage difference between non-inverting terminal and inverting terminal. It can be translated into the input voltage difference required for setting the output voltage at 0 V.

- 2.2 Input offset current (lio) Indicates the difference of input bias current between non-inverting terminal and inverting terminal.
- 2.3 Input bias current (lb) Indicates the current that flows into or out of the input terminal. It is defined by the average of input bias current at non-inverting terminal and input bias current at inverting terminal.
- 2.4 Input common-mode voltage range(Vicm) Indicates the input voltage range where IC operates normally.
- 2.5 Large signal voltage gain (Av) Indicates the amplifying rate (gain) of output voltage against the voltage difference between non-inverting terminal and Inverting terminal. It is normally the amplifying rate (gain) with reference to DC voltage. Av = (Output voltage fluctuation) / (Input offset fluctuation)
- 2.6 Circuit current (ICC) Indicates the IC current that flows under specified conditions and no-load steady status.
- 2.7 Maximum Output Voltage(High) / Maximum Output Voltage(Low) (VOH/VOL) Indicates the voltage range that can be output by the IC under specified load condition. It is typically divided into maximum output voltage High and low. Maximum output voltage high indicates the upper limit of output voltage. Maximum output voltage low indicates the lower limit.
- 2.8 Common-mode rejection ratio (CMRR) Indicates the ratio of fluctuation of input offset voltage when in-phase input voltage is changed. It is normally the fluctuation of DC. CMRR = (Change of Input common-mode voltage)/(Input offset fluctuation)
- 2.9 Power supply rejection ratio (PSRR)
 Indicates the ratio of fluctuation of input offset voltage when supply voltage is changed. It is normally the fluctuation of DC.

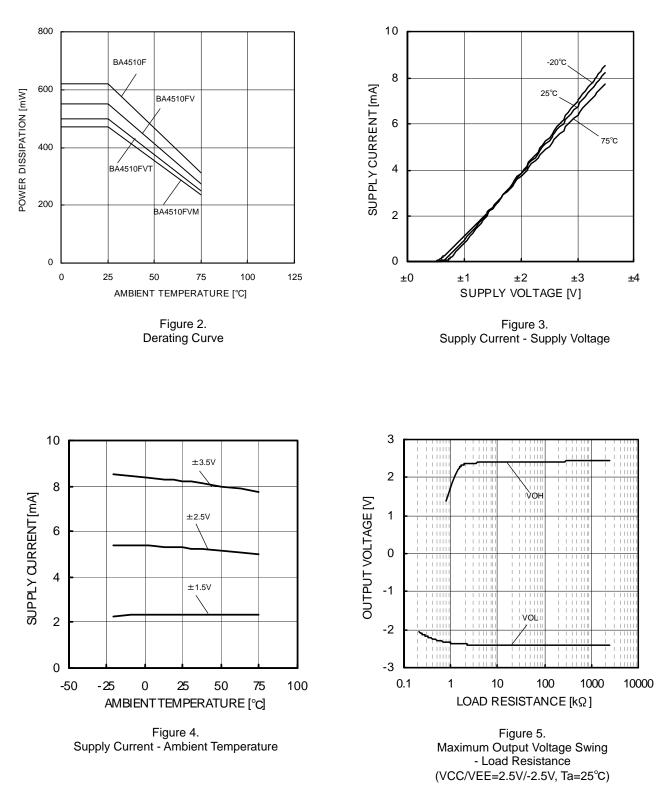
 PSRR = (Change of power supply voltage) / (Input offset fluctuation)
- 2.10 Slew Rate (SR) SR is a parameter that shows movement speed of operational amplifier. It indicates rate of variable output voltage as unit time.
- 2.11 Total harmonic distortion + Noise (THD+N) Indicates the fluctuation of input offset voltage or that of output voltage with reference to the change of output voltage of driven channel.

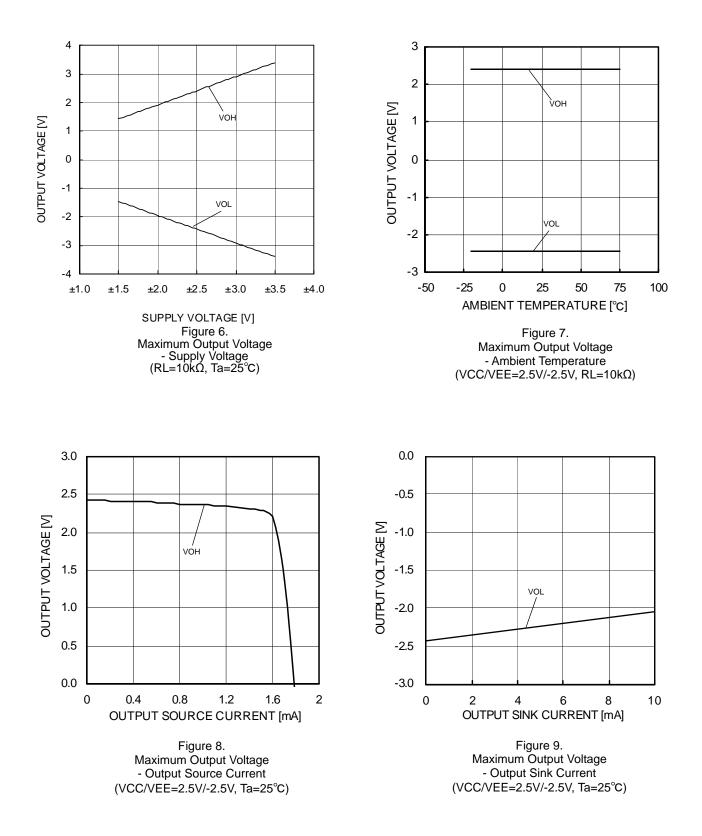
- 2.12 Input referred noise voltage (Vn) Indicates a noise voltage generated inside the operational amplifier equivalent by ideal voltage source connected in series with input terminal.
- 2.13 Channel separation (CS)

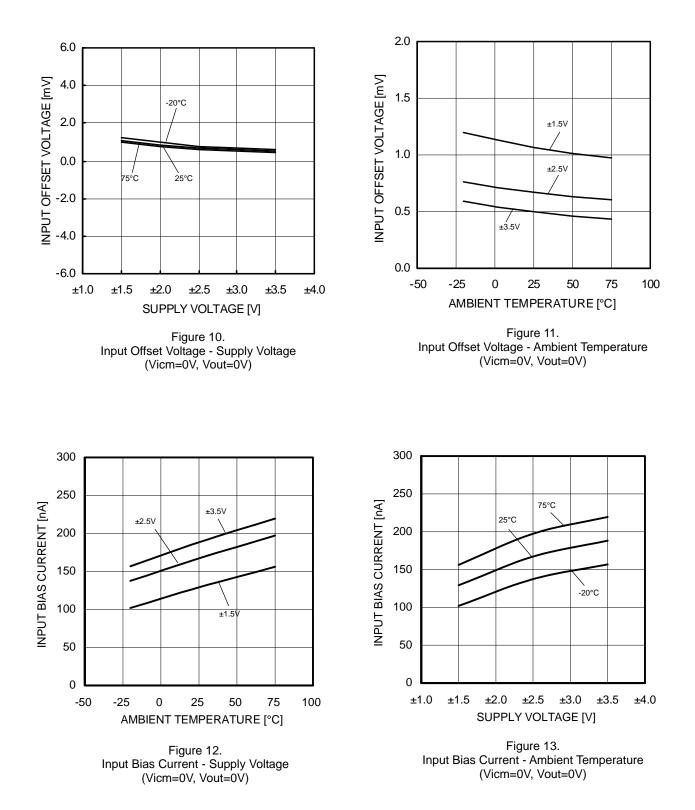
Indicates the fluctuation of input offset voltage or that of output voltage with reference to the change of output voltage of driven channel.

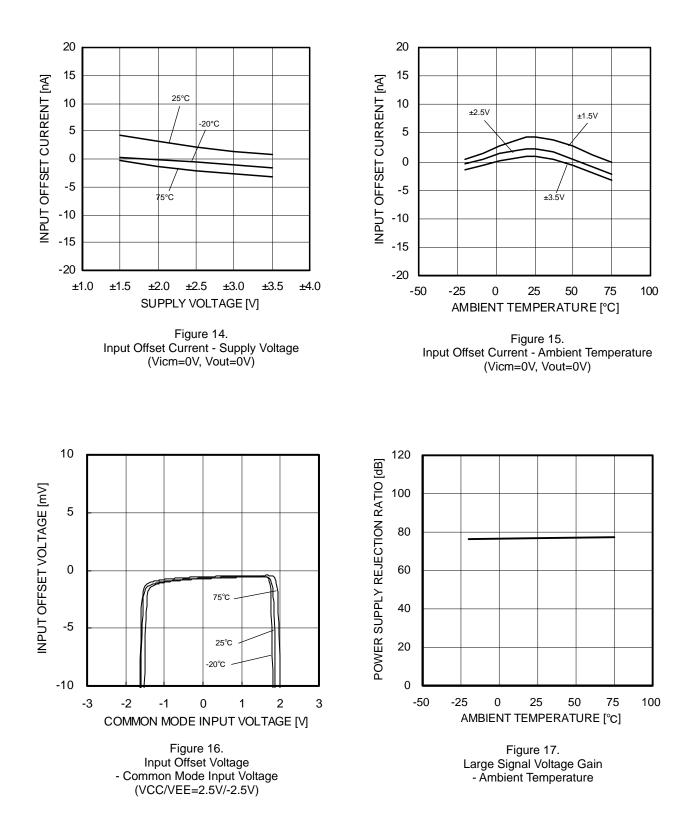
Typical Performance Curves

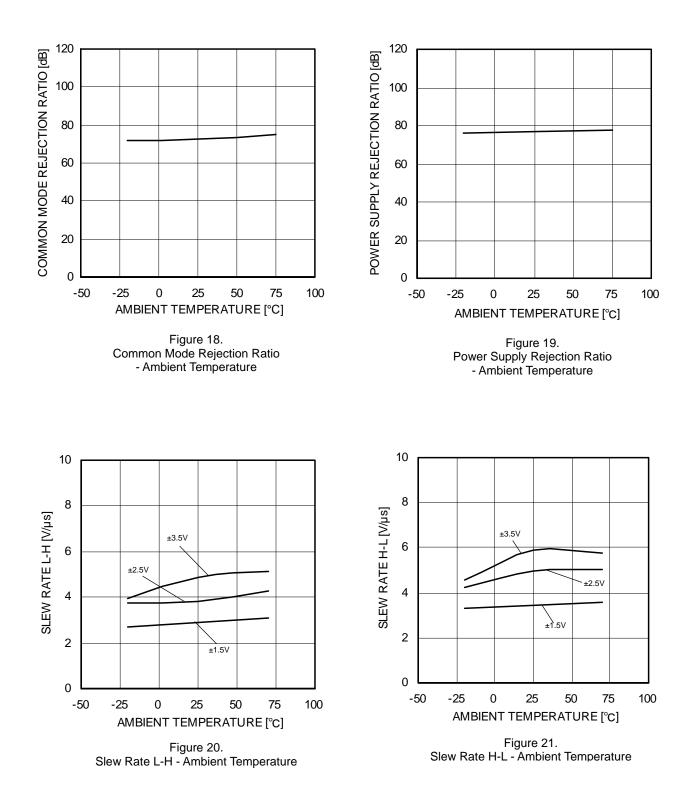
OBA4510



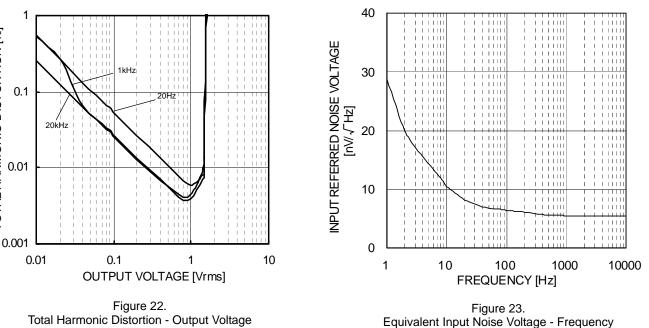








TOTAL HARMONIC DISTORTION [%]



(VCC/VEE=2.5V/-2.5V, RL=3k Ω , 80kHz-LPF, Ta=25°C)

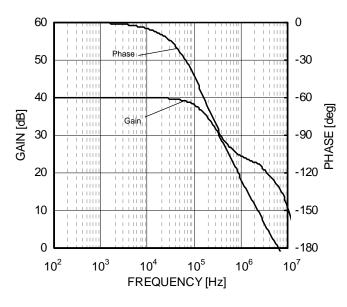


Figure 24. Voltage Gain • Phase - Frequency (VCC/VEE=2.5V/-2.5V, Av=40dB, RL=10kΩ)

(*) The above data is measurement value of typical sample, it is not guaranteed.

(VCC/VEE=2.5V/-2.5V)

Application Information

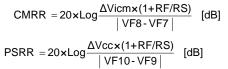
NULL method Condition for Test circuit1

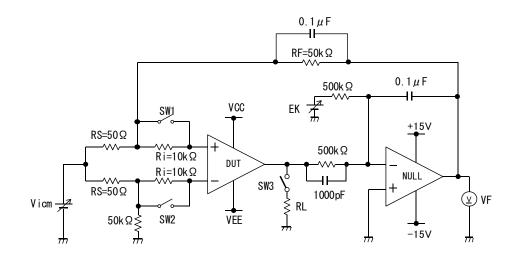
| | | | | | | VC | C, VEE | , EK, V | icm Unit: V | |
|------------------------------------|------|-----|-----|-----|-----|------|--------|---------|-----------------|--|
| Parameter | VF | S1 | S2 | S3 | VCC | VEE | ΕK | Vicm | calculatio n | |
| Input Offset Voltage | VF1 | ON | ON | OFF | 2.5 | -2.5 | 0 | 0 | 1 | |
| Input Offset Current | VF2 | OFF | OFF | OFF | 2.5 | -2.5 | 0 | 0 | 2 | |
| Input Pige Current | VF3 | OFF | ON | OFF | 2.5 | -2.5 | 0 | 0 | 3 | |
| Input Bias Current | VF4 | ON | OFF | OFF | 2.5 | -2.5 | 0 | 0 | 3 | |
| | VF5 | ON | ON | ON | 2.5 | -2.5 | 0 | 0 | 4 | |
| Large Signal Voltage Gain | VF6 | ON | ON | ON | 2.5 | -2.5 | 0 | 0 | 4 | |
| Common-mode Rejection Ratio (Input | VF7 | | ON | | 1 | -4 | 0 | 0 | 5 | |
| common-mode Voltage Range) | VF8 | ON | ON | OFF | 3.8 | -1.2 | 0 | 0 | 5 | |
| Power Supply | VF9 | | ON | OFF | 1 | -1 | 0 | 0 | 6 | |
| Rejection Ratio | VF10 | ON | UN | OFF | 2.5 | -2.5 | 0 | 0 | Ö | |

-Calculation-

1. Input Offset Voltage (Vio)
$$Vio = \frac{|VF1|}{1+RF/RS}$$
 [V]2. Input Offset Current (Iio) $Iio = \frac{|VF2 - VF1|}{Ri \times (1+RF/RS)}$ [A]3. Input Bias Current (Ib) $Ib = \frac{|VF4 - VF3|}{2 \times Ri \times (1+RF/RS)}$ [A]4. Large Signal Voltage Gain (Av) $Av = 20 \times Log \frac{\Delta EK \times (1+RF/RS)}{|VF5 - VF6|}$ [dB]5. Common-mode Rejection Ration (CMRR) $CMRR = 20 \times Log \frac{\Delta Vicm \times (1+RF/RS)}{|VF8 - VF7|}$ [d]

6. Power supply rejection ratio (PSRR)

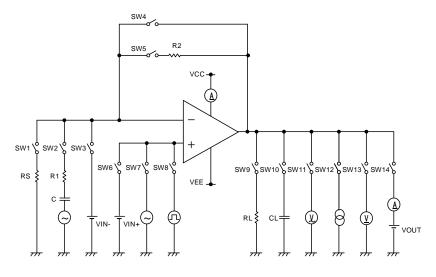




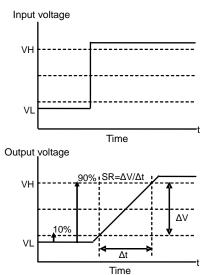


Switch Condition for Test Circuit 2

| SW No. | SW1 | SW2 | SW3 | SW4 | SW5 | SW6 | SW7 | SW8 | SW9 | SW10 | SW11 | SW12 | SW13 | SW14 |
|--------------------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|------|------|------|------|------|
| Supply Current | OFF | OFF | OFF | ON | OFF | ON | OFF | OFF | OFF | OFF | OFF | OFF | OFF | OFF |
| Maximum Output Voltage(High) | OFF | OFF | ON | OFF | OFF | ON | OFF | OFF | ON | OFF | OFF | OFF | ON | OFF |
| Maximum Output Voltage(Low) | OFF | OFF | ON | OFF | OFF | ON | OFF | OFF | OFF | OFF | OFF | OFF | ON | OFF |
| Output Source Current | OFF | OFF | ON | OFF | OFF | ON | OFF | OFF | OFF | OFF | OFF | OFF | OFF | ON |
| Output Sink Current | OFF | OFF | ON | OFF | OFF | ON | OFF | OFF | OFF | OFF | OFF | OFF | OFF | ON |
| Slew Rate | OFF | OFF | OFF | ON | OFF | OFF | OFF | ON | ON | ON | OFF | OFF | OFF | OFF |
| Gain Bandwidth Product | OFF | ON | OFF | OFF | ON | ON | OFF | OFF | ON | ON | OFF | OFF | OFF | OFF |
| Equivalent Input Noise Voltage | ON | OFF | OFF | OFF | ON | ON | OFF | OFF | OFF | OFF | ON | OFF | OFF | OFF |









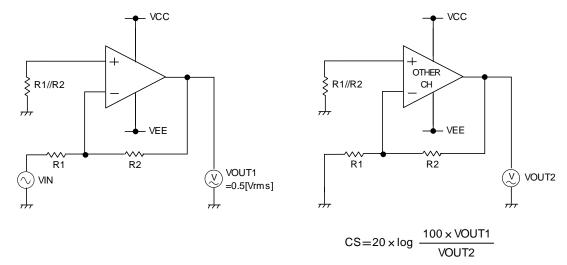


Figure 28. Test Circuit 3 (Channel Separation) (VCC=+2.5V. VEE=-2.5V, R1=100Ω, R2=10kΩ)

Power Dissipation

Power dissipation(total loss) indicates the power that can be consumed by IC at Ta=25°C(normal temperature). IC is heated when it consumed power, and the temperature of IC chip becomes higher than ambient temperature. The temperature that can be accepted by IC chip depends on circuit configuration, manufacturing process, and consumable power is limited. Power dissipation is determined by the temperature allowed in IC chip(maximum junction temperature) and thermal resistance of package(heat dissipation capability). The maximum junction temperature is typically equal to the maximum value in the storage temperature range. Heat generated by consumed power of IC radiates from the mold resin or lead frame of the package. The parameter which indicates this heat dissipation capability(hardness of heat release) is called thermal resistance, represented by the symbol θja°C/W. The temperature of IC inside the package can be estimated by this thermal resistance. Figure 29. (a) shows the model of thermal resistance of the package. Thermal resistance θja, ambient temperature Ta, maximum junction temperature Tjmax, and power dissipation Pd can be calculated by the equation below:

> $\theta_{ja} = (T_{jmax}-T_{a}) / Pd$ °C/W

(I) Derating curve in Figure 29. (b) indicates power that can be consumed by IC with reference to ambient temperature. Power that can be consumed by IC with reference to ambient temperature. Power that can be consumed by IC begins to attenuate at certain ambient temperature. This gradient is determined by thermal resistance θja. Thermal resistance θja depends on chip size, power consumption, package, ambient temperature, package condition, wind velocity, etc even when the same of package is used. Thermal reduction curve indicates a reference value measured at a specified condition. Figure 30. (c) show a derating curve for an example of BA4510.

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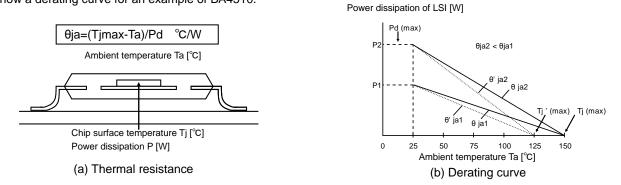
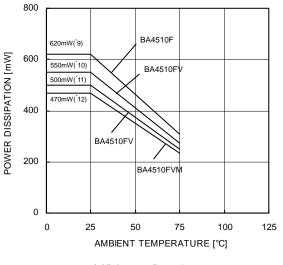


Figure 29. Thermal resistance and derating curve





| (*9) | (*10) | (*11) | (*12) | Unit |
|------|-------|-------|-------|-------|
| 6.2 | 5.5 | 5.0 | 4.8 | mW/°C |

When using the unit above Ta=25°C, subtract the value above per degree°C. Permissible dissipation is the value. Permissible dissipation is the value when FR4 glass epoxy board 70mm x10mm x1.6mm (cooper foil area below 3%) is mounted.

Figure 30. Derating curve

Application examples

OVoltage follower

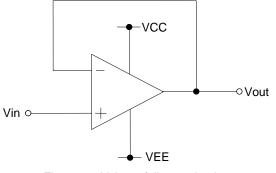


Figure 31. Voltage follower circuit

OInverting amplifier

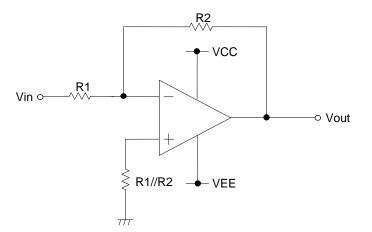


Figure 32. Inverting amplifier circuit

ONon-inverting amplifier

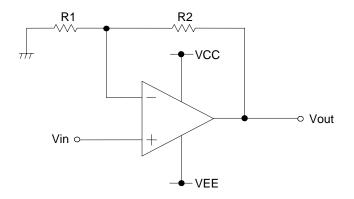


Figure 33. Non-inverting amplifier circuit

Voltage gain is 0 dB.

This circuit controls output voltage (Vout) equal input voltage (Vin), and keeps Vout with stable because of high input impedance and low output impedance. Vout is shown next expression. Vout=Vin

For inverting amplifier, Vin is amplified by voltage gain decided R1 and R2, and phase reversed voltage is output. Vout is shown next expression.

Vout=-(R2/R1) · Vin Input impedance is R1.

For non-inverting amplifier, Vin is amplified by voltage gain decided R1 and R2, and phase is same with Vin. Vout is shown next expression. Vout= $(1 + R2/R1) \cdot Vin$ This circuit performs high input impedance because

This circuit performs high input impedance because Input impedance is operational amplifier's input Impedance.

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Operational Notes

1) Processing of unused circuit

It is recommended to apply connection (see the Figure 34.) and set the non inverting input terminal at the potential within input common-mode voltage range (Vicm), for any unused circuit.

- Input voltage Please note that the circuit operates normally only when the input voltage is within the common mode input voltage range of the electric characteristics.
- 3) Maximum output voltage

Because the output voltage range becomes narrow as the output current Increases, design the application with margin by considering changes in electrical characteristics and temperature characteristics.

4) Short-circuit of output terminal

When output terminal and VCC or VEE terminal are shorted, excessive Output current may flow under some conditions, and heating may destroy IC. It is necessary to connect a resistor as shown in Figure 35. thereby protecting against load shorting.

- 5) Power supply (split supply / single supply) in used Op-amp operates when specified voltage is applied between VCC and VEE. Therefore, the single supply Op-Amp can be used for double supply Op-Amp as well.
- 6) Power dissipation (Pd)

Use a thermal design that allows for a sufficient margin in light of the power dissipation (Pd) in actual operating conditions.

- Short-circuit between pins and wrong mounting Pay attention to the assembly direction of the ICs. Wrong mounting direction or shorts between terminals, GND, or other components on the circuits, can damage the IC.
- Use in strong electromagnetic field Using the ICs in strong electromagnetic field can cause operation malfunction.
- Radiation This IC is not designed to be radiation-resistant.
- 10) Handing of IC

When stress is applied to IC because of deflection or bend of board, the characteristics may fluctuate due to piezo resistance effects.

11) Inspection on set board

During testing, turn on or off the power before mounting or dismounting the board from the test Jig. Do not power up the board without waiting for the output capacitors to discharge. The capacitors in the low output impedance terminal can stress the device. Pay attention to the electro static voltages during IC handling, transportation, and storage.

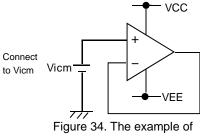
12) Output capacitor

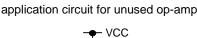
When VCC terminal is shorted to VEE (GND) potential and an electric charge has accumulated on the external capacitor, connected to output terminal, accumulated charge may be discharged VCC terminal via the parasitic element within the circuit or terminal protection element. The element in the circuit may be damaged (thermal destruction). When using this IC for an application circuit where there is oscillation, output capacitor load does not occur, as when using this IC as a voltage comparator. Set the capacitor connected to output terminal below 0.1µF in order to prevent damage to IC.

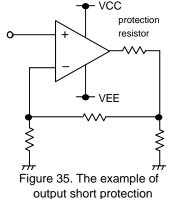
Status of this document

The Japanese version of this document is formal specification. A customer may use this translation version only for a reference to help reading the formal version.

If there are any differences in translation version of this document formal version takes priority.

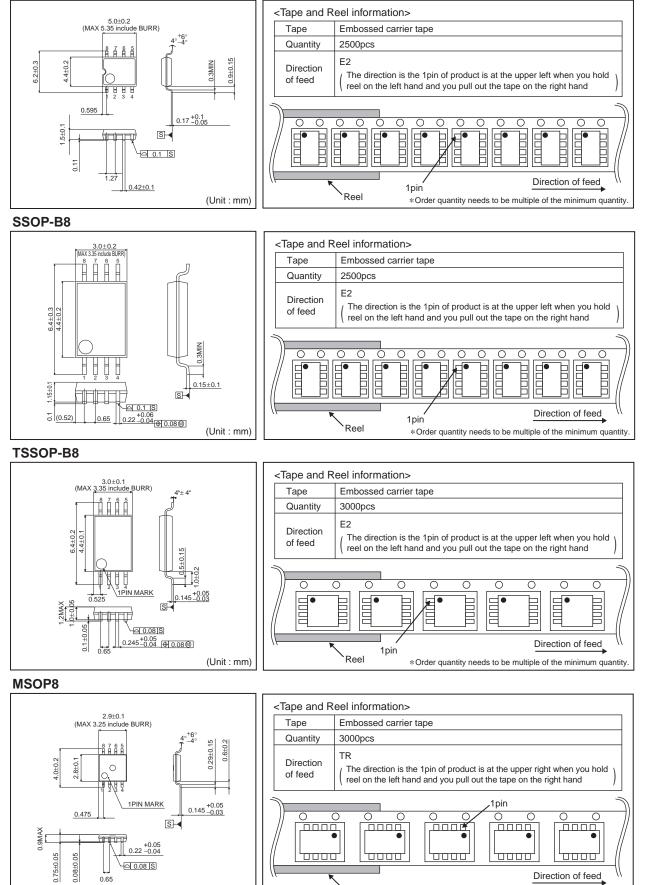






Physical Dimensions Tape and Reel Information

SOP8

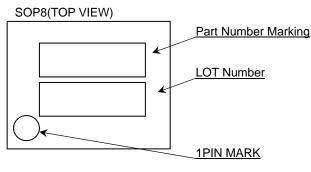


Reel

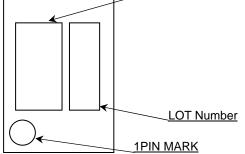
(Unit : mm)

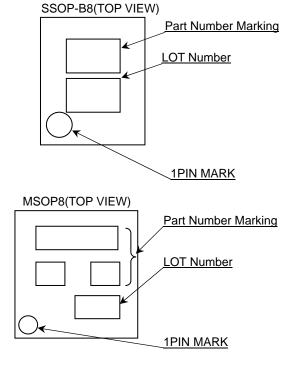
*Order quantity needs to be multiple of the minimum quantity

Marking Diagrams



TSSOP-B8(TOP VIEW) Part Number Marking

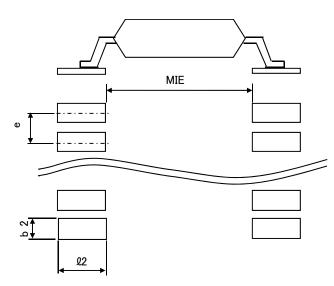




| Product N | Product Name | | Marking | | | |
|-----------|--------------|----------|---------|--|--|--|
| | F | SOP8 | | | | |
| BA4510 | FV | SSOP-B8 | 4510 | | | |
| BA4510 | FVT | TSSOP-B8 | 4010 | | | |
| | FVM | MSOP8 | | | | |

Land pattern data

| and pattern data | | | all din | nensions in mm |
|------------------|-----------------|-------------------|---------------------|------------------|
| PKG | Land pitch e | Land space MIE | Land length ≧ℓ 2 | Land width b2 |
| SOP8 | 1.27 | 4.60 | 1.10 | 0.76 |
| SSOP-B8 | 0.65 | 4.60 | 1.20 | 0.35 |
| TSSOP-B8 | 0.65 | 4.60 | 1.20 | 0.35 |
| MSOP8 | 0.65 | 2.62 | 0.99 | 0.35 |



Revision History

| Date | Revision | Changes |
|-----------|----------|-------------|
| 2012.11.7 | 001 | New Release |

Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

| JAPAN | USA | EU | CHINA |
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| CLASSⅢ | CLASSⅢ | CLASS II b | CLASSI |
| CLASSⅣ | | CLASSⅢ | |

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
 - [a] Installation of protection circuits or other protective devices to improve system safety
 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [C] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

Precaution for Foreign Exchange and Foreign Trade act

Since our Products might fall under controlled goods prescribed by the applicable foreign exchange and foreign trade act, please consult with ROHM representative in case of export.

Precaution Regarding Intellectual Property Rights

- 1. All information and data including but not limited to application example contained in this document is for reference only. ROHM does not warrant that foregoing information or data will not infringe any intellectual property rights or any other rights of any third party regarding such information or data. ROHM shall not be in any way responsible or liable for infringement of any intellectual property rights or other damages arising from use of such information or data.:
- 2. No license, expressly or implied, is granted hereby under any intellectual property rights or other rights of ROHM or any third parties with respect to the information contained in this document.

Other Precaution

- 1. This document may not be reprinted or reproduced, in whole or in part, without prior written consent of ROHM.
- 2. The Products may not be disassembled, converted, modified, reproduced or otherwise changed without prior written consent of ROHM.
- 3. In no event shall you use in any way whatsoever the Products and the related technical information contained in the Products or this document for any military purposes, including but not limited to, the development of mass-destruction weapons.
- 4. The proper names of companies or products described in this document are trademarks or registered trademarks of ROHM, its affiliated companies or third parties.

General Precaution

- 1. Before you use our Products, you are requested to care fully read this document and fully understand its contents. ROHM shall not be in an y way responsible or liable for failure, malfunction or accident arising from the use of a ny ROHM's Products against warning, caution or note contained in this document.
- 2. All information contained in this docume nt is current as of the issuing date and subject to change without any prior notice. Before purchasing or using ROHM's Products, please confirm the latest information with a ROHM sale s representative.
- 3. The information contained in this document is provided on an "as is" basis and ROHM does not warrant that all information contained in this document is accurate an d/or error-free. ROHM shall not be in an y way responsible or liable for any damages, expenses or losses incurred by you or third parties resulting from inaccuracy or errors of or concerning such information.